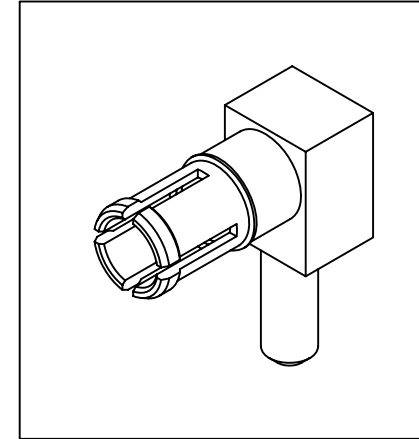
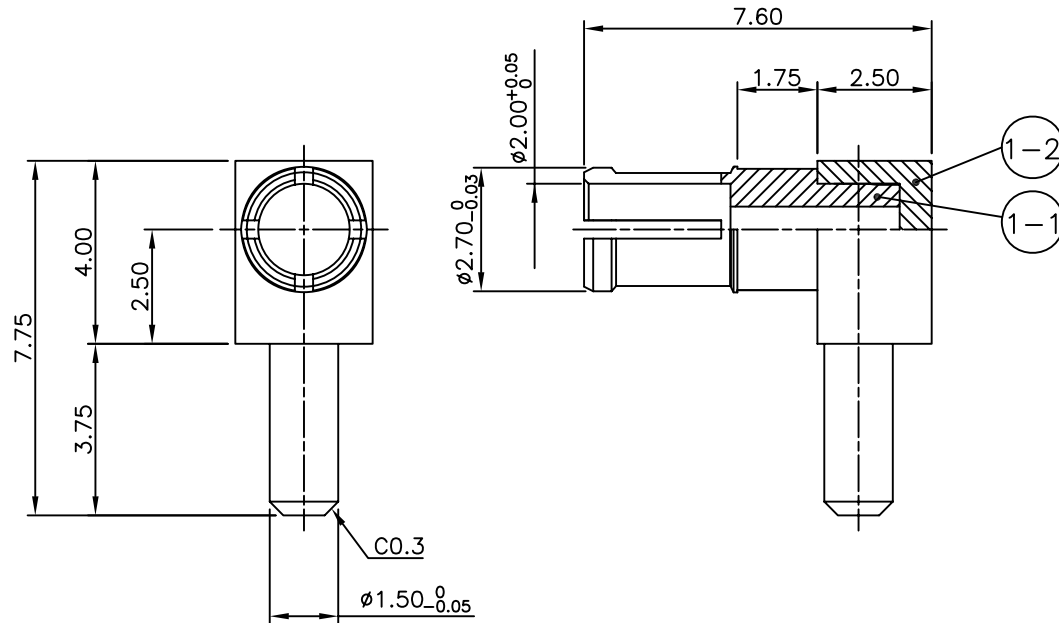


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.10.10.



1	1-2	BODY (B)	1	BeCu C17300	Gold Plate (0.5 μ m)	DBB00494-5/1	DBD04567-1/1
	1-1	BODY (A)	1	BeCu C17300			DBD04566-4/1
NO.		DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	
DATE 2019. 10. 10.				 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.			
APPROVED BY		I.C.KIM					
CHECKED BY				TITLE HP30 JL-C 하이 파워 소켓 핀 (30-3400-CMM, RA PCB, HPP-PR30)			
DRAWN BY		S.Y.EUN					
SCALE 6/1		UNIT mm		A4	DWG NO. CN03886-7/1		
					REVISION I R	SHEET 1 of 1	